

CMOS Low Cost 10-Bit Multiplying DAC

AD7533

FEATURES

Lowest Cost 10-Bit DAC
Low Cost AD7520 Replacement
Linearity: 1/2, 1 or 2LSB
Low Power Dissipation
Full Four-Quadrant Multiplying DAC
CMOS/TTL Direct Interface
Latch Free (Protection Schottky not Required)

APPLICATIONS
Digitally Controlled Attenuators
Programmable Gain Amplifiers
Function Generation
Linear Automatic Gain Control

GENERAL DESCRIPTION

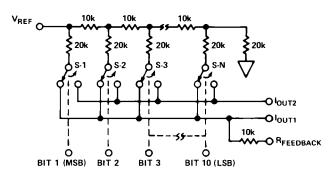
End-Point Linearity

The AD7533 is a low cost 10-bit 4-quadrant multiplying DAC manufactured using an advanced thin-film-on-monolithic-CMOS wafer fabrication process.

Pin and function equivalent to the industry standard AD7520, the AD7533 is recommended as a lower cost alternative for old AD7520 sockets or new 10-bit DAC designs.

AD7533 application flexibility is demonstrated by its ability to interface to TTL or CMOS, operate on +5V to +15V power, and provide proper binary scaling for reference inputs of either positive or negative polarity.

Functional Block Diagram



DIGITAL INPUTS (DTL/TTL/CMOS COMPATIBLE)

Logic: A switch is closed to I_{OUT1} for its digital input in a "HIGH" state.

ORDERING GUIDE¹

Model ²	Temperature Range	Nonlinearity (% FSR max)	Package Option ³
AD7533JN	$-40^{\circ}\text{C to} + 85^{\circ}\text{C}$	± 0.2	N-16
AD7533KN	-40° C to $+85^{\circ}$ C	± 0.1	N-16
AD7533LN	-40° C to $+85^{\circ}$ C	± 0.05	N-16
AD7533JP	-40° C to $+85^{\circ}$ C	± 0.2	P-20A
AD7533KP	-40° C to $+85^{\circ}$ C	± 0.1	P-20A
AD7533LP	-40°C to +85°C	± 0.05	P-20A
AD7533JR	- 40°C to + 85°C	± 0.2	R-16
AD7533KR	-40° C to $+85^{\circ}$ C	± 0.1	R-16
AD7533LR	-40° C to $+85^{\circ}$ C	± 0.05	R-16
AD7533AQ	-40° C to $+85^{\circ}$ C	± 0.2	Q-16
AD7533BQ	-40° C to $+85^{\circ}$ C	± 0.1	Q-16
AD7533CQ	-40°C to $+85^{\circ}\text{C}$	± 0.05	Q-16
AD7533SQ	-55° C to $+125^{\circ}$ C	± 0.2	Q-16
AD7533TQ	− 55°C to + 125°C	± 0.1	Q-16
AD7533UQ	-55° C to $+125^{\circ}$ C	± 0.05	Q-16
AD7533SE	−55°C to +125°C	± 0.2	E-20A
AD7533TE	$-55^{\circ}\text{C to} + 125^{\circ}\text{C}$	± 0.1	E-20A
AD7533UE	$-55^{\circ}\text{C to} + 125^{\circ}\text{C}$	± 0.05	E-20A

NOTES

¹Analog Devices reserves the right to ship ceramic (package outline D-16) packages in lieu of cerdip (package outline Q-16) packages.

²To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet.

³E = Leadless Ceramic Chip Carrier; N = Plastic DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = SOIC.

REV. A

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AD7533 — SPECIFICATIONS $(V_{DD} = +15V, V_{OUT1} = V_{OUT2} = 0V; V_{REF} = +10V \text{ unless otherwise noted})$

PARAMETER	$T_A = 25^{\circ}C$	$T_A = Operating Range$	Test Conditions	
STATIC ACCURACY				
Resolution	10 Bits	10 Bits		
Relative Accuracy ¹				
AD7533JN, AD, SD, AQ, SQ	± 0.2% FSR max	±0.2% FSR max		
AD7533KN, BD, TD, BQ, TQ	± 0.1% FSR max	± 0.1% FSR max		
AD7533LN, CD, UD, CQ, UQ	± 0.05% FSR max	± 0.05% FSR max		
Gain Error ^{2,3}	± 1.4% FS max	± 1.5% FS max	Digital Inputs = V _{INH}	
Supply Rejection ⁴				
$\Delta Gain/\Delta V_{DD}$	0.005%/%	0.008%/%	Digital Inputs = V_{INH} ; V_{DD} = +14V to +17V	
Output Leakage Current				
I_{OUT1}	± 50nA max	± 200nA max	Digital Inputs = V_{INL} ; $V_{REF} = \pm 10V$	
I _{OUT2}	± 50nA max	± 200nA max	Digital Inputs = V_{INH} ; $V_{REF} = \pm 10V$	
DYNAMIC ACCURACY				
Output Current Settling Time	600ns max ⁴	800ns ⁵	To 0.05% FSR; $R_{LOAD} = 100\Omega$; Digital	
	_	_	Inputs = V_{INH} to V_{INL} or V_{INL} to V_{INH}	
Feedthrough Error	± 0.05% FSR max ⁵	± 0.1% FSR max ⁵	Digital Inputs = V_{INL} ; $V_{REF} = \pm 10V$,	
			100kHz sine wave.	
REFERENCE INPUT			_	
Input Resistance (Pin 15)	$5k\Omega$ min, $20k\Omega$ max	$5k\Omega \min, 20k\Omega \max^6$		
ANALOG OUTPUTS				
Output Capacitance		1		
C _{OUT1}	100pF max ⁵	100pF max ⁵	D': 11 17	
C _{OUT2}	35pF max ⁵	35pF max ⁵	Digital Inputs = V _{INH}	
C _{OUT1}	35pF max ⁵	35pF max ⁵		
C _{OUT2}	100pF max ⁵	100pF max ⁵	Digital Inputs = V _{INL}	
	100pi max	Toopi max		
DIGITAL INPUTS				
Input High Voltage				
V_{INH}	2.4V min	2.4V min		
Input Low Voltage	0.077	0.077		
V _{INL}	0.8V max	0.8V max		
Input Leakage Current		1		
I _{IN}	± 1μA max	$\pm 1\mu A \max$	$V_{IN} = 0V$ and V_{DD}	
Input Capacitance	0.5	0.5		
C _{IN}	8pF max ⁵	8pF max ⁵		
POWER REQUIREMENTS				
V_{DD}	$+15V \pm 10\%$	$+15V \pm 10\%$	Rated Accuracy	
V _{DD} Range ⁵	+5V to +16V	+5V to +16V	Functionality with Degraded Performance	
I_{DD}	2mA max	2mA max	Digital Inputs = V_{INL} or V_{INH}	

NOTES

1"FSR" is Full-Scale Range.

 $^{^{2}}$ Full Scale (FS) = (V_{REF})

³Max gain change from $T_A = +25^{\circ}\text{C}$ to T_{min} or T_{max} is $\pm 0.1\%$ FSR.

⁴AC parameter, sample tested to ensure specification compliance.

⁵Guaranteed, not tested.

⁶Absolute temperature coefficient is approximately – 300ppm/°C.

Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*

$(T_A = +25^{\circ}C \text{ unless otherwise noted})$
V_{DD} to GND
R_{FB} to GND
V_{REF} to GND
Digital Input Voltage Range $\dots -0.3V$ to $V_{DD} + 0.3V$
OUT 1, OUT 2 to GND $-0.3V$ to V_{DD}
Power Dissipation (Any Package)
To +75°C
Derates above +75°C by
Operating Temperature Range
Plastic (JN, KN, LN versions) 0 to +70°C

Hermetic (AD, BD, CD,		
AQ, BQ, CQ versions)		 -25°C to $+85^{\circ}\text{C}$
Hermetic (SD, TD, UD,		
SQ, TQ, UQ versions)		 -55° C to $+125^{\circ}$ C
Storage Temperature		 -65° C to $+150^{\circ}$ C
Lead Temperature (Soldering	, 10sec)	 +300°C

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION: -

ESD (Electro-Static-Discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subjected to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The foam should be discharged to the destination socket before devices are removed.



TERMINOLOGY

RELATIVE ACCURACY: Relative accuracy or end-point nonlinearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for ideal zero and full scale and is expressed in % of full-scale range or (sub) multiples of 1LSB.

RESOLUTION: Value of the LSB. For example, a unipolar converter with n bits has a resolution of (2^{-n}) (V_{REF}). A bipolar converter of n bits has a resolution fo $[2^{-(n-1)}]$ (V_{REF}]. Resolution in no way implies linearity.

SETTLING TIME: Time required for the output function of the DAC to settle to within 1/2LSB for a given digital input stimulus, i.e., 0 to Full Scale.

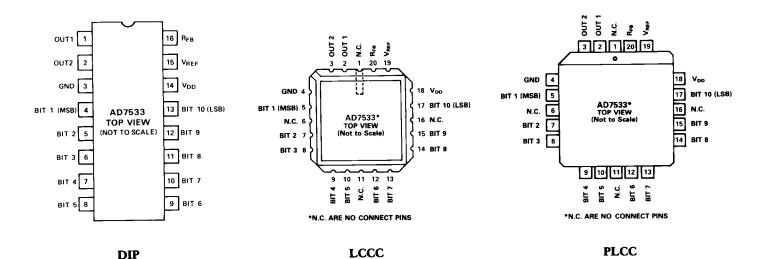
GAIN ERROR: Gain error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1s in the DAC after offset error has been adjusted out and is expressed in Least Significant Bits. Gain error is adjustble to zero with an external potentiometer.

FEEDTHROUGH ERROR: Error caused by capacitive coupling from V_{REF} to output with all switches OFF.

OUTPUT CAPACITANCE: Capacity from $I_{\rm OUT1}$ and $I_{\rm OUT2}$ terminals to ground.

OUTPUT LEAKAGE CURRENT: Current which appears on I_{OUT1} terminal with all digital inputs LOW or on I_{OUT2} terminal when all inputs are HIGH.

PIN CONFIGURATIONS



-3-

AD7533

CIRCUIT DESCRIPTION

GENERAL CIRCUIT INFORMATION

The AD7533, a 10-bit multiplying D/A converter, consists of a highly stable thin film R-2R ladder and ten CMOS current switches on a monolithic chip. Most applications require the addition of only an output operational amplifier and a voltage or current reference.

The simplified D/A circuit is shown in Figure 1. An inverted R-2R ladder structure is used – that is, the binarily weighted currents are switched between the $I_{\rm OUT1}$ and $I_{\rm OUT2}$ bus lines, thus maintaining a constant current in each ladder leg independent of the switch state.

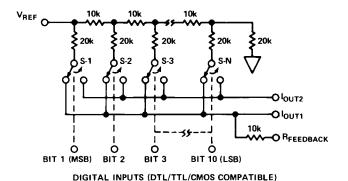


Figure 1. AD7533 Functional Diagram

One of the CMOS current switches is shown in Figure 2. The geometries of devices 1, 2 and 3 are optimized to make the digital control inputs DTL/TTL/CMOS compatible over the full military temperature range. The input stage drives two inverters (devices 4, 5, 6 and 7) which in turn drive the two output N channels. The "ON" resistances of the switches are binarily sealed so the voltage drop across each switch is the same. For example, switch 1 of Figure 2 was designed for an "ON" resistance of 20Ω , switch 2 for 40Ω , and so on. For a 10V reference input, the current through switch 1 is 0.5mA, the current through switch 2 is 0.25mA, and so on, thus maintaining a constant 10mV drop across each switch. It is essential that each switch voltage drop be equal if the binarily weighted current division property of the ladder is to be maintained.

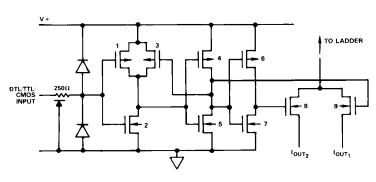


Figure 2. CMOS Switch

EQUIVALENT CIRCUIT ANALYSIS

The equivalent circuits for all digital inputs high and all digital inputs low are shown in Figures 3 and 4. In Figure 3 with all digital inputs low, the reference current is switched to $I_{\rm OUT2}$. The current source $I_{\rm LEAKAGE}$ is composed of surface and junction leakages to the substrate while the $\frac{I}{1024}$ current source represents a constant 1-bit current drain through the termination resistor on the R-2R ladder. The "ON" capacitance of the output N channel switch is 100pF, as shown on the $I_{\rm OUT2}$ terminal. The "OFF" switch capacitance is 35pF, as shown on the $I_{\rm OUT1}$ terminal. Analysis of the circuit for all digital inputs high, as shown in Figure 4, is similar to Figure 3; however, the "ON" switches are now on terminal $I_{\rm OUT1}$, hence the 100pF at that terminal.

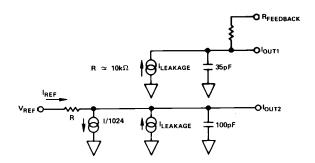


Figure 3. AD7533 Equivalent Circuit – All Digital Inputs Low

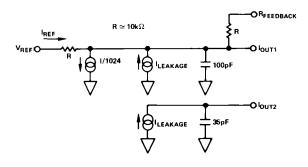


Figure 4. AD7533 Equivalent Circuit – All Digital Inputs High

OPERATION

UNIPOLAR BINARY OPERATION (2-QUADRANT MULTIPLICATION)

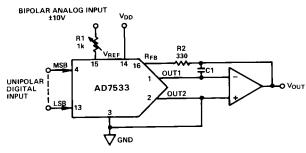
ANALOG OUTPUT (V _{OUT} as shown in Figure 5)
$-V_{REF}\left(\frac{1023}{1024}\right)$
$-V_{REF}\left(\frac{513}{1024}\right)$
$-V_{REF}\left(\frac{512}{1024}\right) = \frac{V_{REF}}{2}$
$-V_{REF}\left(\frac{511}{1024}\right)$
$-V_{REF}\left(\frac{1}{1024}\right)$
$-V_{REF}\left(\frac{0}{1024}\right) = 0$

NOTE:

1. Nominal LSB magnitude for the circuit of

Figure 5 is given by LSB = $V_{REF} \left(\frac{1}{1024} \right)$

Table I. Unipolar Binary Code Table



NOTES:

1. R1 AND R2 USED ONLY IF GAIN ADJUSTMENT IS REQUIRED.

2. C1 PHASE COMPENSATION (5 – 15pF) MAY BE REQUIRED WHEN USING HIGH SPEED AMPLIFIER.

Figure 5. Unipolar Binary Operation (2-Quadrant Multiplication)

BIPOLAR OPERATION (4-QUADRANT MULTIPLICATION)

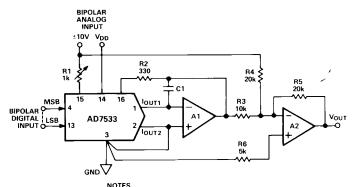
NPUT LSB	ANALOG OUTPUT (V _{OUT} as shown in Figure 6)
1111	$+V_{REF}\left(\frac{511}{512}\right)$
0001	$+ V_{REF} \left(\frac{1}{512} \right)$
0000	0
1111	$-V_{REF}\left(\frac{1}{512}\right)$
0001	$-V_{REF}\left(\frac{511}{512}\right)$
0000	$-V_{REF}\left(\frac{512}{512}\right)$
	LSB 1 1 1 1 1 0 0 0 0 1 0 0 0 0 0 1 1 1 1 1

NOTE

1. Nominal LSB magnitude for the circuit of

Figure 6 is given by LSB = $V_{REF} \left(\frac{1}{512} \right)$

Table II. Bipolar (Offset Binary) Code Table



NOTES

1. R3, R4 AND R5 SELECTED FOR MATCHING AND TRACKING.

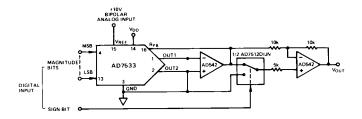
2. R1, R2 USED ONLY IF GAIN ADJUSTMENT IS REQUIRED.

3. C1 PHASE COMPENSATION (5-15pF) MAY BE REQUIRED WHEN USING HIGH SPEED AMPLIFIERS.

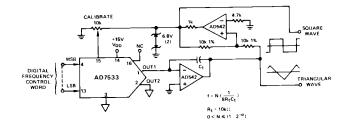
Figure 6. Bipolar Operation (4-Quadrant Multiplication)

APPLICATIONS

10-BIT AND SIGN MULTIPLYING DAC



PROGRAMMABLE FUNCTION GENERATOR



16-PIN PLASTIC DIP (SUFFIX N) ሊሊሊሊሊሊ

abla
abl

0.755 (19.18)

0.745 (18.93)

0.065 (1.66) 0.02 (0.508)

0.045 (1.15) | 0.015 (0.381)

0.012 (0.305) 0.008 (0.203)

LEAD NO. 1 IDENTIFIED BY DOT OR NOTCH

LEADS ARE SOLDER OR TIN-PLATED KOVAR OR ALLOY 42

0.306 (7.78)

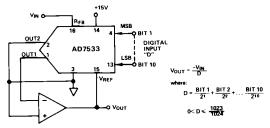
0.294 (7.47)

0.17 (4.32)

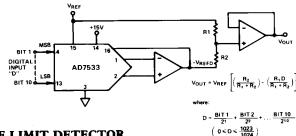
MAX

0.175 (4.45) 0.12 (3.05)

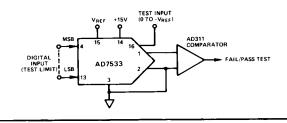
DIVIDER (DIGITALLY CONTROLLED GAIN)



MODIFIED SCALE FACTOR AND OFFSET



DIGITALLY PROGRAMMABLE LIMIT DETECTOR

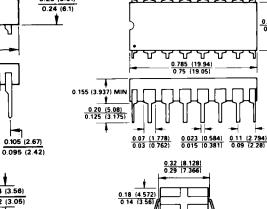


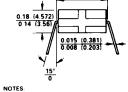
OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

0.30 (7.62)

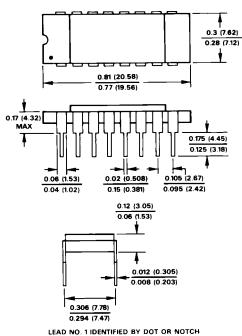
16-PIN CERDIP (SUFFIX Q) 0.26 (6.61) χ χ χ





NOTES: LEAD NO. 1 IDENTIFIED BY DOT OR NOTCH. LEADS ARE SOLDER OF TIN-PLATED KOVAR OR ALLOY 42.

16-PIN CERAMIC DIP (SUFFIX D)



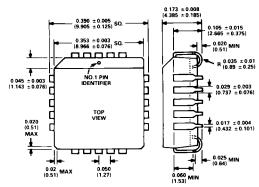
LEADS WILL BE EITHER GOLD OR TIN PLATED IN ACCORDANCE WITH MIL-M38510 REQUIREMENTS

20-TERMINAL PLASTIC LEADED **CHIP CARRIER (SUFFIX P)**

0.105 (2.67)

0.14 (3.56)

0.12 (3.05)



20-TERMINAL LEADLESS CHIP CARRIER (SUFFIXE)

